

Refining & Chemicals Polymers

Technical data sheet
High Density Polyethylene CAPS & CLOSURES
Produced in Europe

Description

HD 6042 is a high density polyethylene (HDPE) offering a high stiffness and enhanced Environmental Stress Crack Resistance (ESCR). Its processability is similar to a MFR 8 standard HDPE grade.

It has been specifically designed for the manufacture of caps and closures requiring high processability, high stiffness, excellent tearing properties such as for tethered caps. It also shows an excellent behavior to living hinge constraints.

HD 6042 is a pellet grade and contains antioxidants.

Characteristics

Property	Method	Unit	Typical value (*)
Density	ISO 1183	g/cm³	0.960
Melt Flow Rate (190°C/2.16 kg)	ISO 1133/D	g/10 min	4
Tensile modulus	ISO 527	MPa	1400
Tensile strength at yield	ISO 527	MPa	30
ESCR Antarox 100% (50 °C)	ASTM D 1693	hrs	F ₅₀ = 14
Melting temperature	ISO 11357	°C	133

^(*) Data not intended for specification purposes

Handling and storage

Please refer to the safety data sheet (SDS) for handling and storage information. It is advisable to convert the product within one year after delivery provided storage conditions are used as given in the SDS of our product. SDS may be obtained from the website: www.polymers.totalenergies.com.

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